

MiniSKiiP® 0

3-phase bridge inverter

SKiiP 04AC066V1

Features

- Trench IGBT's
- · Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications*

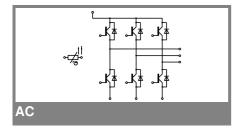
- Inverter up to 6,3 kVA
- Typical motor power 4,0 kW

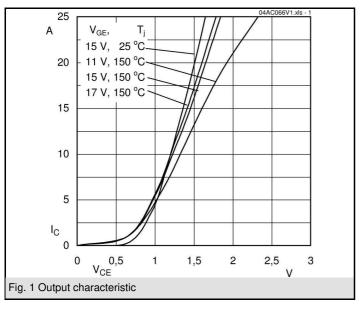
Remarks

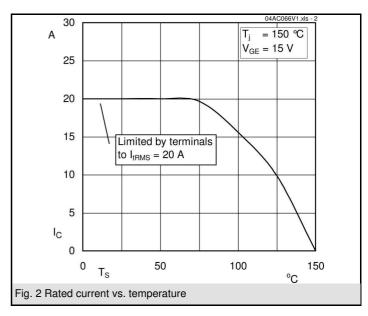
- Case temperature limited to T_C= 125°C max., product reliability results are valid for $T_j = 150$ °C
- SC data: $t_p \le 6$ s; $V_{GE} \le 15$ V; T_j = 150°C; V_{CC} = 360 V V_{CEsat} , V_F = chip level value Temp.Sensor: No basic insulation
- to main circuit, max. potential difference 850V to -DC

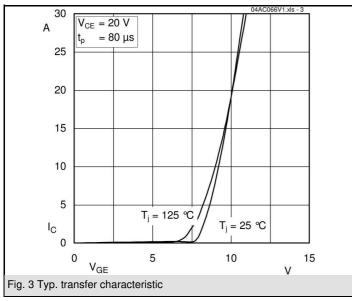
Absolute	$T_S = 25 ^{\circ}C$, unless otherwise	specified						
Symbol	Conditions	Values	Units					
IGBT - Inverter								
V_{CES}		600	V					
I _C	$T_s = 25 (70) ^{\circ}C, T_i = 150 ^{\circ}C$	30 (21)	Α					
I _C	$T_s = 25 (70) ^{\circ}C , T_j = 175 ^{\circ}C$	33 (25)	Α					
I _{CRM}	t _p = 1 ms	40	Α					
V_{GES}		± 20	V					
T _j		-40+175	°C					
Diode - Inverter								
I _F	$T_s = 25 (70) ^{\circ}C, T_i = 150 ^{\circ}C$	24 (16)	Α					
I _F	$T_s = 25 (70) ^{\circ}C, T_i = 175 ^{\circ}C$	31 (23)	Α					
I _{FRM}	$t_p = 1 \text{ ms}$	40	Α					
T _j		-40+175	°C					
I _{tRMS}	per power terminal (20 A / spring)	20	Α					
T _{stg}	$T_{op} \leq T_{stg}$	-40+125	°C					
V _{isol}	AC, 1 min.	2500	V					

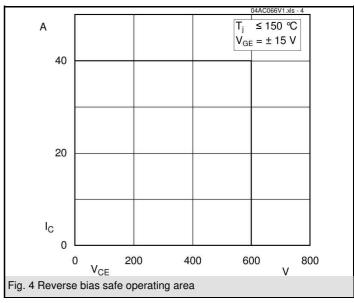
Character	, unless ot	herwise sp	ecified					
Symbol	Conditions	min.	typ.	max.	Units			
IGBT - Inverter								
V _{CEsat}	$I_{Cnom} = 20 \text{ A}, T_j = 25 (150) ^{\circ}\text{C}$	1,1	,	1,85 (2,05)	V			
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 1 \text{ mA}$		5,8		V			
V _{CE(TO)}	$T_j = 25 (150) ^{\circ}C$		0,9 (0,85)	· · /	V			
r _T	$T_{j} = 25 (150) ^{\circ}\text{C}$		30 (42,5)	45 (60)	mΩ			
C _{ies}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		1,13		nF			
C _{oes}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,25		nF			
C _{res}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,18		nF			
R _{CC'+EE'}	spring contact-chip T _s = 25 (150)°C				mΩ			
$R_{th(j-s)}$	per IGBT		1,6		K/W			
t _{d(on)}	under following conditions		15		ns			
t _r	$V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{V}$		30		ns			
t _{d(off)}	I _{Cnom} = 20 A, T _j = 150 °C		175		ns			
t _f	$R_{Gon} = R_{Goff} = 15 \Omega$		45		ns			
$E_{on}(E_{off})$	inductive load		0,8 (0,7)		mJ			
Diode - Inverter								
$V_F = V_{EC}$	$I_{Fnom} = 20 \text{ A}, T_i = 25 (150) ^{\circ}\text{C}$		1,6 (1,65)	1,9 (1,95)	V			
V _(TO)	T _i = 25 (150) °C		1 (0,9)	1,1 (1)	V			
r _T	T _i = 25 (150) °C		30 (37,5)	40 (47,5)	mΩ			
$R_{th(j-s)}$	per diode		2,5		K/W			
I _{RRM}	under following conditions		27		Α			
Q_{rr}	I _{Fnom} = 20 A, V _R = 300 V		2,25		С			
E _{rr}	V _{GE} = 0 V, T _i = 150 °C		0,55		mJ			
	$di_{F}/dt = 1280 \text{ A/ s}$							
Temperature Sensor								
R _{ts}	3 %, T _r = 25 (100) °C		1000(1670)		Ω			
Mechanical Data								
m			21,5		g			
M_s	Mounting torque	2		2,5	Nm			

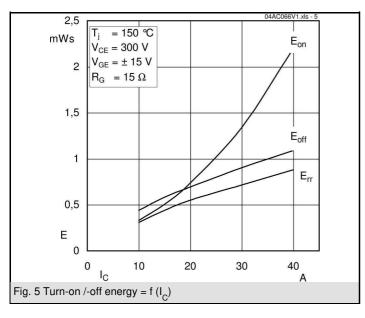


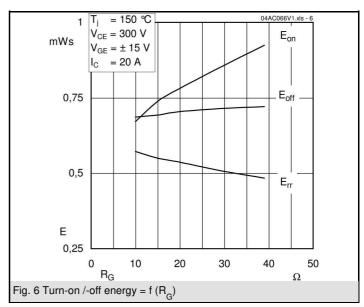


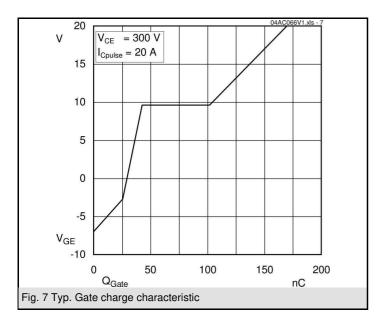


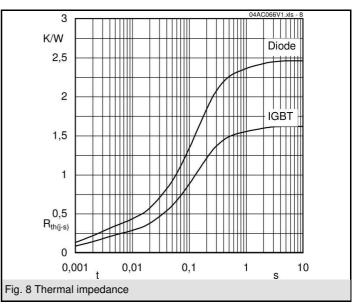


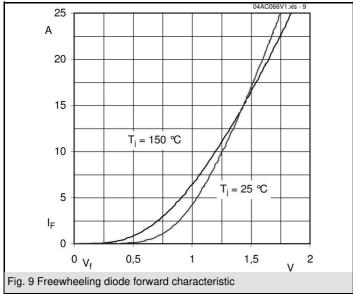


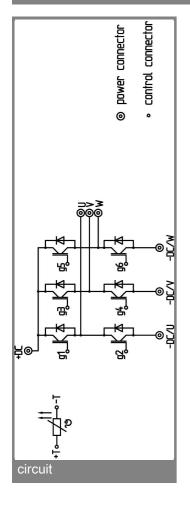


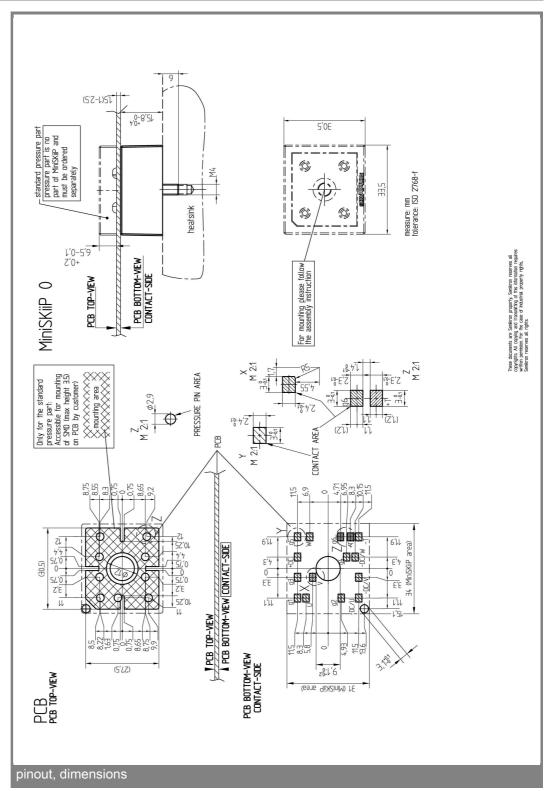












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

^{*} The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.